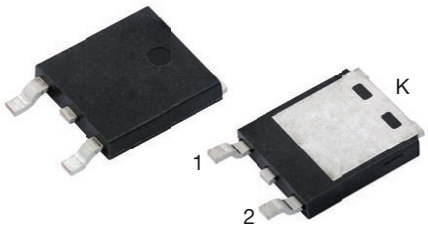
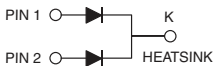
High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low V_F = 0.58 V at I_F = 5 A

eSMP® Series



SlimDPAK (TO-252AE)



FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE Available

RoHS COMPLIANT

HALOGEN FREE

LINKS TO ADDITIONAL RESOURCES

3D Models

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 x 20 A
V_{RRM}	200 V
I_{FSM}	240 A
V_F at I_F = 20 A (T_J = 125 °C)	0.75 V
T_J max.	175 °C
Package	SlimDPAK (TO-252AE)
Circuit configuration	Common cathode

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant
Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified
("_X" denotes revision code e.g. A, B,.....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)				
PARAMETER		**SYMBOL**	**V40PW22C**	**UNIT**
Device marking code			V40PW22C	
Maximum repetitive peak reverse voltage		V_{RRM}	200	V
Maximum average forward rectified current (fig. 1)	per device	$I_{F(AV)}$ (1)	40	A
	per diode	$I_{F(AV)}$ (1)	20	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode		I_{FSM}	240	A
Operating junction temperature range		T_J (2)	-40 to +175	°C
Storage temperature range		T_{STG}	-55 to +175	°C

Notes

(1) With infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

ELECTRICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted)						
PARAMETER	**TEST CONDITIONS**		**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Maximum instantaneous forward voltage	I_F = 5.0 A	T_J = 25 °C	V_F (1)	0.74	-	V
	I_F = 10 A			0.8	-	
	I_F = 20 A			0.89	0.97	
	I_F = 5.0 A	T_J = 125 °C		0.58	-	
	I_F = 10 A			0.65	-	
	I_F = 20 A			0.75	0.83	
Reverse current	V_R = 160 V	T_J = 25 °C	I_R (2)	0.0007	-	mA
		T_J = 125 °C		1.5	-	
	V_R = 200 V	T_J = 25 °C		-	0.25	
		T_J = 125 °C		3	10	
Typical junction capacitance	4.0 V, 1 MHz		C_J	700	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**V40PW22C**	**UNIT**
Typical thermal resistance	$R_{\theta JA}$ (1)(2)	65	°C/W
	$R_{\theta JM}$ (3)	1.5	

Notes

(1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB; thermal resistance $R_{\theta JA}$ - junction to ambient

(3) Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	**UNIT WEIGHT (g)**	**PREFERRED PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
V40PW22C-M3/I	0.20	I	4500	13" diameter plastic tape and reel
V40PW22CHM3_A/I (1)	0.20	I	4500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

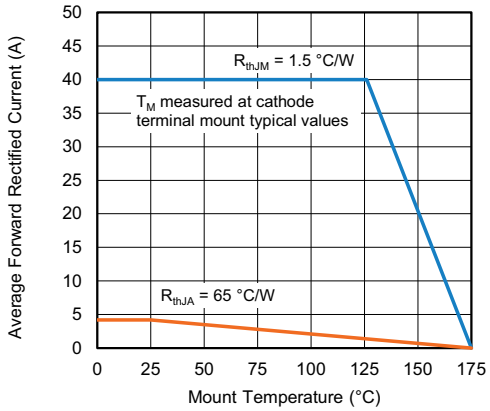


Fig. 1 - Maximum Forward Current Derating Curve

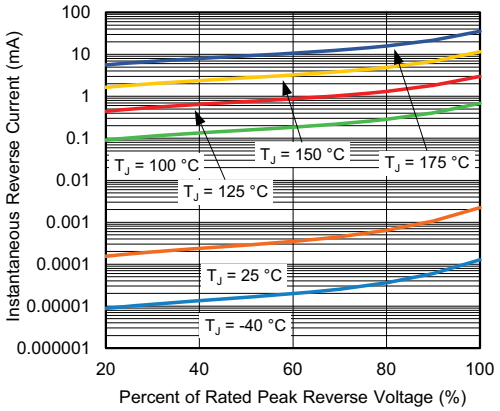


Fig. 4 - Typical Reverse Leakage Characteristics

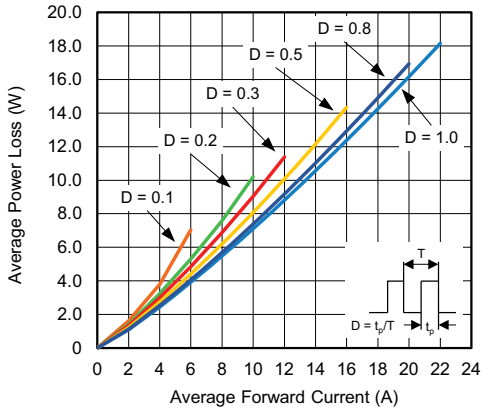


Fig. 2 - Forward Power Loss Characteristics

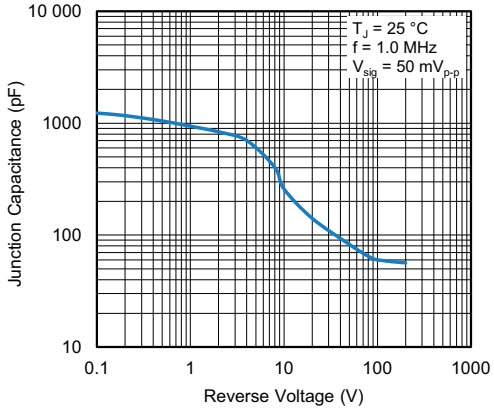


Fig. 5 - Typical Junction Capacitance

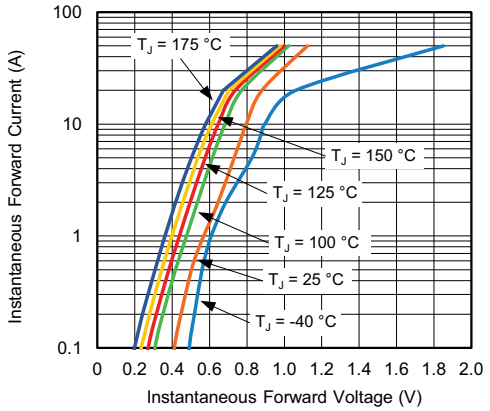


Fig. 3 - Typical Instantaneous Forward Characteristics

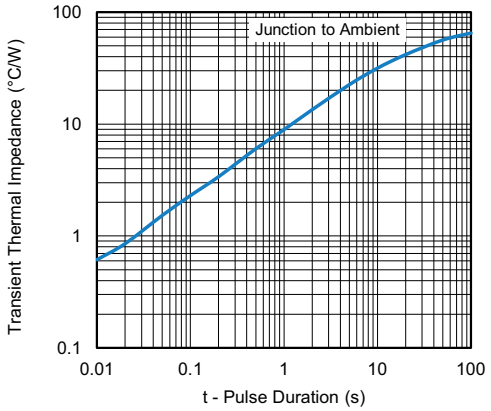


Fig. 6 - Typical Transient Thermal Impedance

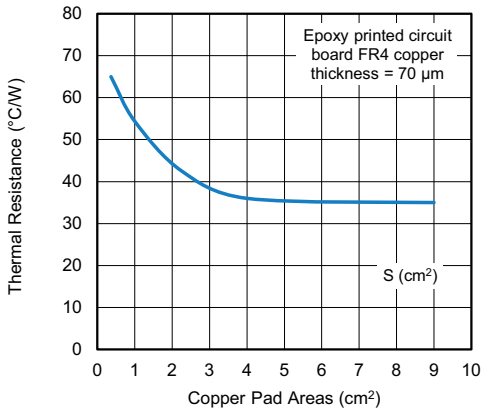
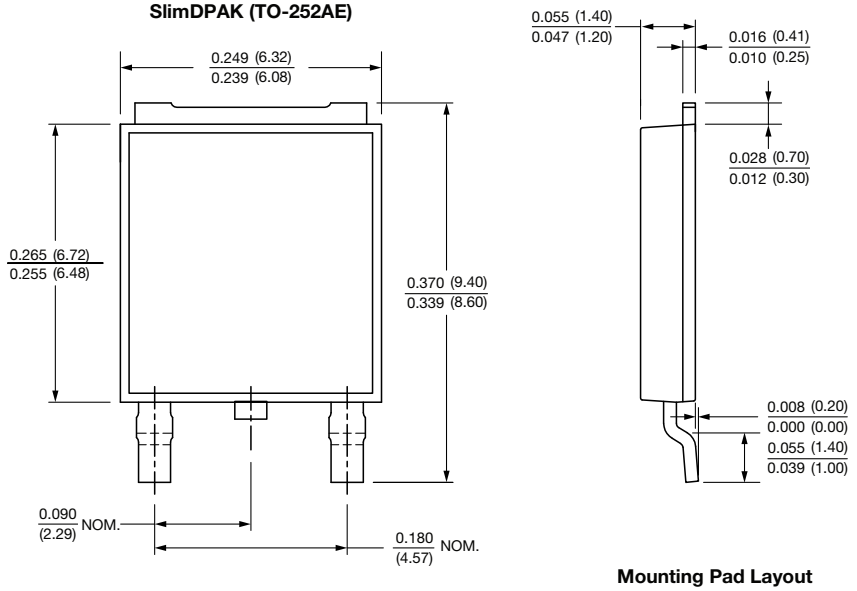


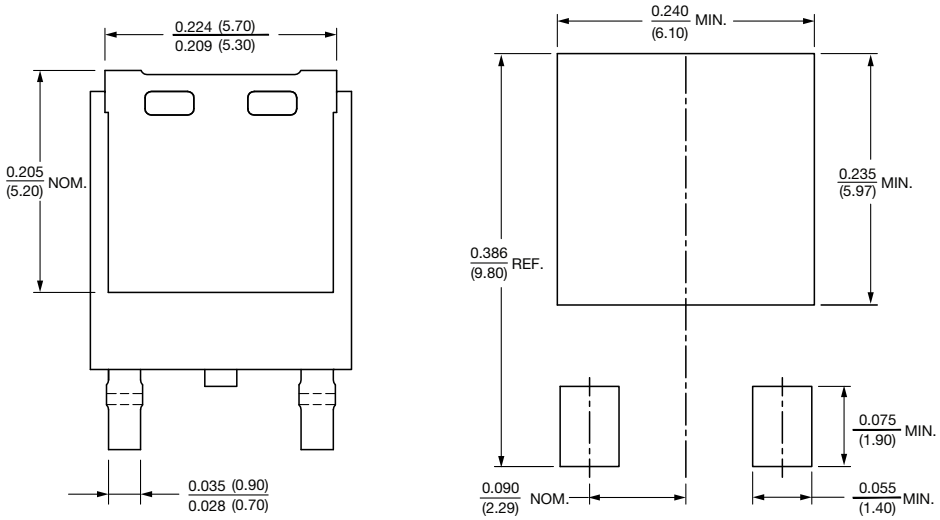
Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimDPAK (TO-252AE)



Mounting Pad Layout



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